

Hybrid Conductive Polymer Aluminum Capacitors SMD (Chip), Low Impedance

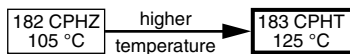


Fig. 1



FEATURES

- Long useful life: up to 4000 h at 125 °C
- Very low ESR and high ripple current
- High voltages up to 80 V
- AEC-Q200 qualified products on request
- SMD-version with base plate, lead (Pb)-free reflow solderable
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- Automotive electronics
- Industrial and professional applications
- Telecommunications and IT
- Portable and mobile equipment

MARKING

- Rated capacitance (in μF)
- Rated voltage (in V)
- Date code, in accordance with IEC 60062
- Black mark or “-” sign indicating the cathode (the anode is identified by beveled edges)
- Code indicating group number (83)

PACKAGING

Supplied in blister tape on reel

QUICK REFERENCE DATA	
DESCRIPTION	VALUE
Nominal case sizes (L x W x H in mm)	5.0 x 5.0 x 5.8 to 10.0 x 10.0 x 10.5
Rated capacitance range, C_R	10 μF to 330 μF
Tolerance on C_R	$\pm 20\%$
Rated voltage range, U_R	25 V to 80 V
Category temperature range	-55 °C to +125 °C
Endurance test at 125 °C	4000 h
Useful life at 125 °C	4000 h
Shelf life at 0 V, 125 °C	1000 h
Based on sectional specification	IEC 60384-25 / CECC 32300
Climatic category IEC 60068	55 / 125 / 56

SELECTION CHART FOR C_R , U_R , AND RELEVANT NOMINAL CASE SIZES (L x W x H in mm)					
C_R (μF)	U_R (V)				
	25	35	50	63	80
10	→	→	5.0 x 5.0 x 5.8	6.3 x 6.3 x 5.8	-
22	→	5.0 x 5.0 x 5.8	6.3 x 6.3 x 5.8	6.3 x 6.3 x 7.7	8.0 x 8.0 x 10.5
33	5.0 x 5.0 x 5.8	→	6.3 x 6.3 x 7.7	8.0 x 8.0 x 10.5	10.0 x 10.0 x 10.5
47	→	6.3 x 6.3 x 5.8	→	→	10.0 x 10.0 x 10.5
56	6.3 x 6.3 x 5.8	→	→	10.0 x 10.0 x 10.5	-
68	→	6.3 x 6.3 x 7.7	8.0 x 8.0 x 10.5	10.0 x 10.0 x 10.5	-
100	6.3 x 6.3 x 7.7	→	10.0 x 10.0 x 10.5	-	-
120	→	→	10.0 x 10.0 x 10.5	-	-
150	→	8.0 x 8.0 x 10.5	-	-	-
220	8.0 x 8.0 x 10.5	-	-	-	-
270	→	10.0 x 10.0 x 10.5	-	-	-
330	10.0 x 10.0 x 10.5	-	-	-	-

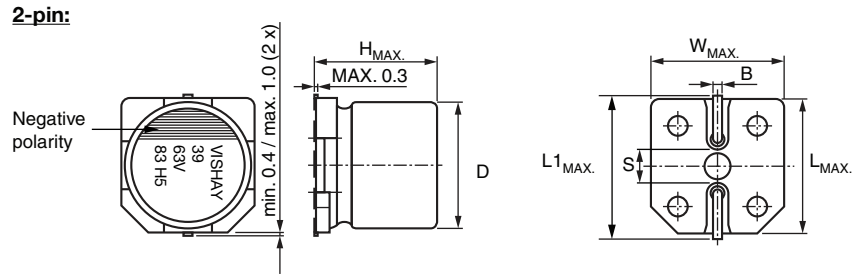


Fig. 2 - Dimensional outline

Table 1

DIMENSIONS in millimeters AND MASS									
NOMINAL CASE SIZE L x W x H	CASE CODE	L _{MAX.}	W _{MAX.}	H _{MAX.}	Ø D	B _{MAX.}	S	L1 _{MAX.}	MASS (g)
5.0 x 5.0 x 5.8	0506	5.5	5.5	6.1	5.0	0.8	1.4	6.1	0.2
6.3 x 6.3 x 5.8	0606	6.7	6.7	6.1	6.3	0.8	2.2	7.4	0.3
6.3 x 6.3 x 7.7	0608	6.7	6.7	8.0	6.3	0.8	2.2	7.4	0.4
8.0 x 8.0 x 10.5	0810	8.5	8.5	10.8	8.0	1.1	3.1	9.2	0.9
10.0 x 10.0 x 10.5	1010	10.5	10.5	10.8	10.0	1.1	4.5	11.2	1.2

Table 2

TAPE AND REEL DIMENSIONS in millimeters, PACKAGING QUANTITIES						
NOMINAL CASE SIZE L x W x H	CASE CODE	PITCH P ₁	TAPE WIDTH W	TAPE THICKNESS T ₂	REEL DIAMETER	PACKAGING QUANTITY PER REEL
5.0 x 5.0 x 5.8	0506	12	12	6.1	380	1000
6.3 x 6.3 x 5.8	0606	12	16	5.7	380	1000
6.3 x 6.3 x 7.7	0608	12	16	8.0	380	900
8.0 x 8.0 x 10.5	0810	16	24	11.0	380	500
10.0 x 10.0 x 10.5	1010	16	24	11.0	380	500

MOUNTING

The capacitors are designed for automatic placement on to printed-circuit boards.

Optimum dimensions of soldering pads depend amongst others on soldering method, mounting accuracy, print layout and / or adjacent components.

For recommended soldering pad dimensions, refer to Fig. 3 and Table 3.

SOLDERING

Soldering conditions are defined by the curve, temperature versus time, where the temperature is that measured on the component during processing.

For maximum conditions refer to Fig. 4.

Any temperature versus time curve which does not exceed the specified maximum curves may be applied.

As a general principle, temperature and duration shall be the **minimum** necessary required to ensure good soldering connections. However, the specified maximum curves should never be exceeded.

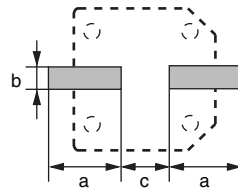


Fig. 3 - Recommended soldering pad dimensions

Table 3

RECOMMENDED SOLDERING PAD DIMENSIONS in millimeters				
NOMINAL CASE SIZE L x W x H	CASE CODE	a	b	c
5.0 x 5.0 x 5.8	0506	3.0	1.6	1.4
6.3 x 6.3 x 5.8	0606	3.5	1.6	2.1
6.3 x 6.3 x 7.7	0608	3.5	1.6	2.1
8.0 x 8.0 x 10.5	0810	4.2	1.9	2.8
10.0 x 10.0 x 10.5	1010	4.4	1.9	4.3

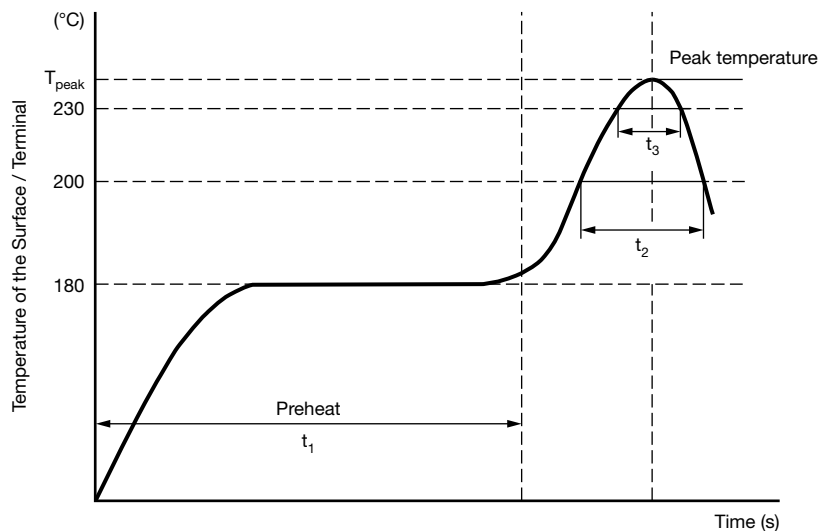
SOLDERING PROFILE FOR LEAD (Pb)-FREE REFLOW PROCESS


Fig. 4 - Maximum temperature load during reflow soldering

Table 4

REFLOW SOLDERING CONDITIONS for MAL2183xxxxxE3		
PROFILE FEATURES	25 V	35 V TO 80 V
Maximum time between 150 °C to 180 °C (t_1)	120 s	120 s
Maximum time above 200 °C (t_2)	80 s	70 s
Maximum time above 230 °C (t_3)	50 s	30 s
Peak temperature T_{Peak}	240 °C	240 °C
Maximum reflow cycles	2	1

Note

- Temperature measuring point on top of the case and on terminals



ELECTRICAL DATA	
SYMBOL	DESCRIPTION
C_R	Rated capacitance at 120 Hz, tolerance $\pm 20\%$
I_R 125 °C	Rated RMS ripple current at 100 kHz
I_{L2}	Max. leakage current after 2 min at U_R
$\tan \delta$	Max. dissipation factor at 120 Hz
ESR	Max. ESR at 100 kHz

Note

- Unless otherwise specified, all electrical values in Table 5 apply at $T_{amb} = 20\text{ °C}$, $P = 86\text{ kPa}$ to 106 kPa , $RH = 45\%$ to 75%

Table 5

ELECTRICAL DATA AND ORDERING INFORMATION							
U_R (V)	C_R (μF)	NOMINAL CASE SIZE L x W x H (mm)	I_R 125 °C 100 kHz (mA)	I_{L2} 2 min (μA)	$\tan \delta$ 120 Hz	ESR 100 kHz 20 °C ($\text{m}\Omega$)	ORDERING CODE MAL2183...
25	33	5.0 x 5.0 x 5.8	550	8.3	0.14	80	97601E3
	56	6.3 x 6.3 x 5.8	900	14	0.14	50	97602E3
	100	6.3 x 6.3 x 7.7	1400	25	0.14	30	97603E3
	220	8.0 x 8.0 x 10.5	1600	55	0.14	27	97604E3
	330	10.0 x 10.0 x 10.5	2000	82.5	0.14	20	97605E3
35	22	5.0 x 5.0 x 5.8	550	7.7	0.12	100	97001E3
	47	6.3 x 6.3 x 5.8	900	16.5	0.12	60	97002E3
	68	6.3 x 6.3 x 7.7	1400	23.8	0.12	35	97003E3
	150	8.0 x 8.0 x 10.5	1600	52.5	0.12	27	97004E3
	270	10.0 x 10.0 x 10.5	2000	94.5	0.12	20	97005E3
50	10	5.0 x 5.0 x 5.8	500	5	0.1	120	97101E3
	22	6.3 x 6.3 x 5.8	750	11	0.1	80	97102E3
	33	6.3 x 6.3 x 7.7	1100	16.5	0.1	40	97103E3
	68	8.0 x 8.0 x 10.5	1250	34	0.1	30	97104E3
	100	10.0 x 10.0 x 10.5	1600	50	0.1	28	97105E3
	120	10.0 x 10.0 x 10.5	1600	60	0.1	28	97106E3
63	10	6.3 x 6.3 x 5.8	700	6.3	0.08	120	97801E3
	22	6.3 x 6.3 x 7.7	900	13.9	0.08	80	97802E3
	33	8.0 x 8.0 x 10.5	1100	20.8	0.08	40	97803E3
	56	10.0 x 10.0 x 10.5	1400	35.3	0.08	30	97804E3
	68	10.0 x 10.0 x 10.5	1400	42.8	0.08	30	97805E3
80	22	8.0 x 8.0 x 10.5	1050	17.6	0.08	45	97806E3
	33	10.0 x 10.0 x 10.5	1360	26.4	0.08	36	97701E3
	47	10.0 x 10.0 x 10.5	1360	37.6	0.08	36	97702E3

Table 6

ADDITIONAL ELECTRICAL DATA		
PARAMETER	CONDITIONS	VALUE
Voltage		
Surge voltage for short periods	IEC 60384-25, subclause 4.14	$U_S \leq 1.15 \times U_R$

**USEFUL LIFE AND ENDURANCE**

Table 7

ENDURANCE TEST AND USEFUL LIFE							
SERIES	CASE CODE	USEFUL LIFE AT 125 °C (h) ⁽¹⁾	ENDURANCE AT 125 °C (h)	ENDURANCE AT 105 °C (h)	ENDURANCE AT 85 °C (h)	ENDURANCE AT 75 °C (h)	ENDURANCE AT 65 °C (h)
183 CPHT	0506 to 1010	4000	4000	16 000	64 000	128 000	256 000

Note

⁽¹⁾ Identical with endurance for this series

Endurance can be calculated by formula below:

$$L = L_{T_{max.}} \times 2^{\frac{T_{max.} - T_a}{10}}$$

L: estimated lifetime (h)

$L_{T_{max.}}$: base lifetime specified at maximum operating temperature with applied DC voltage (h)

$T_{max.}$: rated maximum operating temperature (°C)

T_a : actual ambient temperature (°C)

Table 8

MULTIPLIER OF RIPPLE CURRENT (I_R) AS A FUNCTION OF FREQUENCY			
FREQUENCY (Hz)			
120	1000	10 000	≥ 100 000
I_R MULTIPLIER			
0.1	0.3	0.6	1

Table 9

TEST PROCEDURES AND REQUIREMENTS			
TEST		PROCEDURE (quick reference)	REQUIREMENTS
NAME OF TEST	REFERENCE		
Mounting	IEC 60384-25, subclause 4.3	Shall be performed prior to tests mentioned below; reflow soldering; for maximum temperature load refer to chapter "Mounting"	$\Delta C/C: \pm 5 \%$ $\tan \delta \leq \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$
Endurance	IEC 60384-25 / CECC 32300, subclause 4.15	$T_{amb} = 125 \text{ °C}$; U_R applied; for test duration see Table 7	$\Delta C/C: \pm 30 \%$ $\tan \delta \leq 2 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$ $ESR \leq 2 \times \text{spec. limit}$
Useful life	CECC 30301, subclause 1.8.1	$T_{amb} = 125 \text{ °C}$; U_R and I_R applied; for test duration see Table 7	$\Delta C/C: \pm 30 \%$ $\tan \delta \leq 2 \times \text{spec. limit}$ $I_{L2} \leq \text{spec. limit}$ $ESR \leq 2 \times \text{spec. limit}$
Shelf life (storage at high temperature)	IEC 60384-25 / CECC 32300, subclause 4.16	$T_{amb} = 125 \text{ °C}$; no voltage applied; 1000 h after test: U_R to be applied for 30 min, 24 h to 48 h before measurement	For requirements see "Endurance test" above

Statements about product lifetime are based on calculations and internal testing. They should only be interpreted as estimations. Also due to external factors, the lifetime in the field application may deviate from the calculated lifetime. In general, nothing stated herein shall be construed as a guarantee of durability.